<u>查询I V2105供应商</u> Ordering number: EN4876B

捷多邦,专业PCB打样工厂,24小时加急出货





Overview

The LV2105V is a PLL frequency synthesizer Bi-CMOS LSI that provides low-voltage operation and low current drain, and that is suitable for use in a variety of radio equipment.

Functions

- PLL function
- Data input by serial transfer (CCB format)
- Input amplifier for crystal oscillation circuit
- Data output port

Features

- Low operating voltage: ($V_{CC} = 2.5$ to 5.5 V)
- Low current drain (5.5 mA)
- Compact package (SSOP16, 0.65 mm pitch)
- VCO band switching data output port on chip
- Data can be input while in power saving mode
- Data input pin high level can be input at V_{CC} or higher
- Independent setting of CP ON/OFF (high impedance) possible

Specifications

Absolute Maximum Ratings at Ta = 25 °C

Package Dimensions

3178-SSOP16



- CCB is a trademark of SANYO ELECTRIC CO., LTD.
- CCB is SANYO's original bus format and all the bus
- addresses are controlled by SANYO.

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V _{CC} max	V _{CC} max V _{CC} R, V _{CC} D		V
Maximum input valtage	V _{IN} max(1)	CE, CL, DI	-0.3 to +6.0	V
Maximum input voltage	V _{IN} max(2)	XIN, TEST	-0.3 to V _{CC} +0.3	V
Maximum output voltage	V _{OUT} max(1)	PDP	-0.3 to +9.0	V
	V _{OUT} max(2)	PDN, OUT, <mark>PE</mark>	–0.3 to V _{CC} +0.3	V
Maximum output current	I _{OUT} max	PDP	0 to +1.0	mA
Allowable power dissipation	Pd max	$114 \times 76 \times 1.6 \text{ mm}^3$ When using glass epoxy board	230	mW
Operating temperature	Topr		-40 to +85	°C
Storage temperature	Tstg		-50 to +125	۰C

Pin Assignment



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Allowable Operating Ranges at Ta = -40 to +85 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply voltage	V _{CC}	V _{CC} R, V _{CC} D	2.5		5.5	V
High-level input voltage	High-level input voltage V _{IH} CE, CL, DI		$V_{CC}R \times 0.7$		5.5	V
Low-level input voltage	VIL	CE, CL, DI	0		+0.6	V
Output voltage	V _{OUT}	PDP	0		+7.0	V
Input frequency	f _{IN} (1)	XIN: Sine wave capacitive coupling	5		22	MHz
	f _{IN} (2)	PI: Sine wave capacitive coupling	100		530	MHz
Input amplitude	V _{IN} (1)	XIN: Sine wave capacitive coupling	-12		+10	dBm
	V _{IN} (2)	PI: Sine wave capacitive coupling	-18		0	dBm
Crystal oscillation condition	I oscillation condition Xtal XIN, (XOUT)		5		13	MHz

Electrical Characteristics at Ta = 25 $\,^{\circ}C,\,V_{\rm CC}R$ = 3.0 V, $V_{\rm CC}D$ = 3.0 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Low-level output voltage	V _{OL} (1)	PDP: I _O = 0.5 mA			0.5	V
	V _{OL} (2)	PDN: I _O = 0.5 mA			0.5	V
	V _{OL} (3)	PE: I _O = 0.5 mA			0.5	V
	V _{OL} (4)	OUT: I _O = 2.0 mA			0.5	V
High-level output voltage	V _{OH} (1)	PE: I _O = -0.5 mA	V _{CC} –0.5			V
	V _{OH} (2)	PDN: I _O = -0.5 mA	V _{CC} –0.5			V
Output off look current	I _{OFF} (1)	PDP: V _O = 3.0 V			1.0	μA
	I _{OFF} (2)	CP: V _O = 1.5 V			100	nA
C.P output current I_{CP} CP: V _O = 1.5 V		CP: V _O = 1.5 V	±4.0	±7.5	±11	mA
	I _H (1)	CE, CL, DI: V _I = 3.0 V			5.0	μA
High-level input current	I _H (2)	XIN: $V_I = 3.0 V$	2.3	3.0	4.3	μA
	I _H (3)	TEST: $V_{I} = 3.0 V$			5.0	μA
Low-level input current	l _L (1)	CE, CL, DI: $V_I = 0 V$			5.0	μA
	I _L (2)	$XIN: V_I = 0 V$	2.3	3.0	4.3	μA
	I _L (3)	TEST: $V_I = 0 V$			5.0	μA
Internal feedback resistance Rf XIN			1.0		MΩ	
Supply current I _{CC} (1		V _{CC} R, V _{CC} D: *1		5.5	9.0	mA
PS supply current	I _{CC} (2)	V _{CC} R, V _{CC} D: *1		0.4	0.6	mA

*1: XIN = 12.8 MHz, 10 dBm, PI = 400 MHz, 0 dBm, other input pins = 0 V, output, I/O pins = OPEN CP OFF

Equivalent Circuit Block Diagram



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Serial Data (PLL Control Data) Configuration

1) Mode 1: Latch-1 data (Reference divider, other data)





Serial Data (Transfer) Timing



Serial Data Explanation

Pin No.	Control block/data	Internal block		
(1)	Reference frequency data FR0 to FR1	 Data that sets the division ratio of the reference divider. Binary value with FR0 as the LSB. However, the settable division ratio factor is up to 4095. (Actual division ratio) = (Set division ratio) (×2: when DIV is "1") 		
(2)	1/2 divider data DIV	Data that sets whether to use 1/2 DIV or to enter the through state. DIV data Item 0 Through 1 1/2 DIV		

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Pin No.	Control block/data	Internal block		
(3)	Power save data PS	Data that sets the power save mode on or off PS data Item 0 Power save mode 1 Normal operation		
(4)	Output port data OUT	Data that sets the output of the output port OUT data OUT Pin 0 Low 1 High		
(5)	Charge pump ON/OFF data CP	 Data that sets whether to operate the charge pump or to implement high impedance. CP data Item 0 High impedance 1 Normal operation 		
(6)	LSI test data TS1	 LSI test mode switch. Set TS1 = 0. Normally, the TEST pin is connected to GND. 		
(7)	Programmable divider data FP0 to FP16	 Data that sets the division ratio of the programmable divider. Binary value with FP0 as the LSB. However, the settable division ratio factor is up to 131071. 		

Pin Functions

	Pin Name	Pin Function	I/O Style
1	XIN	Reference signal input pin (Xtal oscillation pin)	CMOS input
2	CL	Data input pin	CMOS, No pull-down
3	DI	Data input pin	CMOS, No pull-down
4	CE	Data input pin	CMOS, No pull-down
5	V _{CC} R	ECL block power supply pin	
6	PI	Comparison signal input pin	BIP input
7	GND R	ECL block GND pin	
8	TEST	LSI test pin. Must be connected to GND.	CMOS, No pull-down
9	СР	Built-in charge pump output pin	BIP
10	PDP	Phase comparator output for an external charge pump. If not to be used, connect to GND.	CMOS, Nch open-drain output
11	PDN	Phase comparator output for an external charge pump.	CMOS output
12	GND D	GND pin for circuits except the ECL block	
13	V _{CC} D	Power supply pin for circuits except the ECL block	
14	PE	Phase error output pin for phase comparator	CMOS output
15	OUT	Output port pin for switching external SW.	BIP NPN open-collector output
16	XOUT	Output pin for Xtal oscillation	CMOS output





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